

UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

| APPLICATION NO. | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO. |
|--|------------------------|----------------------|-----------------------|------------------|
| 10/500,253 | 06/25/2004 | Kenji Ito | Q81941 | 8926 |
| 65565 SUGHRUE-26 | 7590 03/22/200 5550 | | EXAMINER | |
| 2100 PENNSYLVANIA AVE. NW WASHINGTON, DC 20037-3213 | | | ELVE, MARIA ALEXANDRA | |
| | | | ART UNIT | PAPER NUMBER |
| | | | 1725 | |
| | | | | |
| SHORTENED STATUTOR | Y PERIOD OF RESPONSE | . MAIL DATE | DELIVERY MODE | |
| 3 MONTHS | | 03/22/2007 | PAPER | |

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

| • | | Application No. | Applicant(s) | | | | |
|---|---|---|---|--|--|--|--|
| Office Action Summary | | 10/500,253 | ITO ET AL. | | | | |
| | | Examiner | Art Unit | | | | |
| | | M. Alexandra Elve | 1725 | | | | |
| | The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply | | | | | | |
| WHIC - Exter after - If NO - Failu Any | ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DY CHEVER IS LONGER, FROM THE MAILING DY CHEVER IS LONGER, FROM THE MAILING DY CHEVER IS SIX (6) MONTHS from the mailing date of this communication. It is period for reply is specified above, the maximum statutory period or reply within the set or extended period for reply will, by statute reply received by the Office later than three months after the mailing ed patent term adjustment. See 37 CFR 1.704(b). | ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim vill apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONE | I. wely filed the mailing date of this of (35 U.S.C. § 133). | | | | |
| Status | | | | | | | |
| 1)🖂 | Responsive to communication(s) filed on 26 De | <u>ecember 2006</u> . | . • | | | | |
| 2a)⊠ | This action is FINAL . 2b) This action is non-final. | | | | | | |
| 3) | Since this application is in condition for allowance except for formal matters, prosecution as to the merits is | | | | | | |
| | closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213. | | | | | | |
| Disposition of Claims | | | | | | | |
| 5)□ 6)⊠ 7)□ | Claim(s) 1-10 is/are pending in the application. 4a) Of the above claim(s) is/are withdray Claim(s) is/are allowed. Claim(s) 1-10 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/o | vn from consideration. | · X · | | | | |
| Applicati | ion Papers | | | | | | |
| 10)⊠ | The specification is objected to by the Examine The drawing(s) filed on <u>25 June 2004</u> is/are: a) Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct The oath or declaration is objected to by the Ex | ☑ accepted or b)☐ objected to drawing(s) be held in abeyance. See ion is required if the drawing(s) is obj | e 37 CFR 1.85(a). jected to. See 37 Ci | | | | |
| Priority under 35 U.S.C. § 119 | | | | | | | |
| 12) ⊠ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) ⊠ All b) □ Some * c) □ None of: 1. □ Certified copies of the priority documents have been received. 2. □ Certified copies of the priority documents have been received in Application No 3. ☒ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. | | | | | | | |
| Attachmen | t(s) | | | | | | |
| | ce of References Cited (PTO-892) | 4) Interview Summary Paper No(s)/Mail Da | | | | | |
| 3) Infon | ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO/SB/08) or No(s)/Mail Date | 5) Notice of Informal F | | | | | |

Art Unit: 1725

DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Owen et al. (USPN 5,841,099) and Koning (USPN 3,632,398) and further in view of Hino (USPN 6,037,103).

Owen et al. discloses the use of laser pulses to form vias in a multilayered target. A first laser output of high power density processes the metallic layer while a second lower power density processes the dielectric layer. Energy densities range from 2.3 to 28.72 J/cm^2 , (one being 14.87 J/cm^2). In one preferred embodiment, a first laser output of high intensity is used to process the metallic layer and a second laser output of equal intensity and greater spot size is used to process an underlying dielectric layer. Conventional CO² lasers typically generate laser output wavelengths of about $10.6 \mu m$. (abstract, figures, col. 2, lines 44-67, col. 3, lines 1-50, col. 11, lines 25-49, cols. 13-14)

Owen et al. discloses processing underlying dielectric layers, but does not specifically teach hardened of the layer.

Koning discloses a laser process for hardening and smoothing plastic materials, which may be used for vias (holes). Koning discloses that generally there is a gradual closing of the holes in the "plastic" material. Hardness negates this.

Art Unit: 1725

It would have been obvious to one of ordinary skill in the art at the time of the invention to use laser hardening, as taught by Koning in the Owen et al. system because of the enhanced board properties, that is, not location of the boards.

Owen et al. discloses the use of a resin and a range of energy densities but does not teach the presence of a polyimide or an energy density less than 2.3 J/cm².

Hino discloses a method for forming holes in a printed wire board. The resin layer is not particularly limited as long as holes can be formed therein by a laser beam output from a laser source and it has an electric insulating property. Examples of the resin include polyester resin, epoxy resin, urethane resin, polystyrene resin, polyethylene resin, polyamide resin, polyimide resin, ABS resin, polycarbonate resin, silicone resin and the like. Of these resins, polyimide resin having superior heat resistance, chemical resistance and mechanical strength is preferred.

The energy density for resin and debris removal is 500 mJ/cm² (that is, 0.5 J/cm²). (abstract, figures, col. 4, lines 50-60, col. 7, lines 10-15, col. 8, lines 24-60, col. 9, lines 50-65, col. 10, lines 13-50)

It would have been obvious to one of ordinary skill in the art at the time of the invention to use a polyimide resin and an energy density of 0.5 J/cm², as taught by Hino, in the Owen et al. and Koning processing because polyimide is a resin and has superior properties and energy densities of greater than 0.2 J/cm² are required in order to reach the residue decomposition energy threshold, thus 0.5 J/cm² meets the threshold without cause undue board damage.

Art Unit: 1725

Claim 7 is rejected under 35 U.S.C. 103(a) as being unpatentable over Owen et al., Koning and Hino as stated in the above paragraph and further in view of Kurosawa et al. (USPN 6,373,026)

Owen et al. and Hino teach a processing time of about 5 ms but not 10us.

Kurosawa et al. discloses a laser beam machining method for a wiring board. The beam irradiation time ranges from 10 to 200 μs, with an energy density of about 20 J/cm2 or more. Thus the wiring board may be drilled to form a through-hole, a blind via hole, grooving and cutting. (abstract, figures, col. 2, lines 55-67, col. 3, lines 25-35, col. 4,lines 40-50, col. 5, lines 15-40, col. 10, lines 15-45, col. 11, lines 33-40, col. 12,lines 9-14)

It would have been obvious to one of ordinary skill in the art at the time of the invention to use a processing time, as taught by Kurosawa et al., in the Owen et al. and Hino process because shorter processing times optimize the manufacturing process and minimize damage.

Response to Arguments

Applicant's arguments filed 12/26/06 have been fully considered but they are not persuasive.

Applicant argues that Owen does not disclose hardening of the insulating layer. The examiner respectfully notes: In response to applicant's arguments against the references individually, one cannot show nonobviousness by attacking references individually where the rejections are based on combinations of references. See *In re*

Art Unit: 1725

Keller, 642 F.2d 413, 208 USPQ 871 (CCPA 1981); In re Merck & Co., 800 F.2d 1091, 231 USPQ 375 (Fed. Cir. 1986).

Applicant argues that Koning does not teach the energy density. The examiner respectfully notes: In response to applicant's arguments against the references individually, one cannot show nonobviousness by attacking references individually where the rejections are based on combinations of references. See *In re Keller*, 642 F.2d 413, 208 USPQ 871 (CCPA 1981); *In re Merck & Co.*, 800 F.2d 1091, 231 USPQ 375 (Fed. Cir. 1986).

Applicant argues that Owen does not teach a carbon dioxide laser or the wavelength. The examiner respectfully disagrees because in col. 2, lines 45-47, Owen states: "Convention CO_2 lasers... typically generate laser output wavelengths of about 10.6 μ m..."

Conclusion

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

Art Unit: 1725

the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to M. Alexandra Elve whose telephone number is 571-272-1173. The examiner can normally be reached on 6:30-3:00 Monday to Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Patrick J. Ryan can be reached on 571-272-1292. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

March 19, 2007.

M. Alexandra Elve Primary Examiner 1725